### VACANCY-IMPURITY INTERACTIONS IN ION-IMPLANTED SILICON

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# Outline

- Ion induced defects
- Positron annihilation
- Chemical "fingerprints"
- Migration energies

# Vacancy production

- silicon implantation into silicon at 500keV generates
  ~2900 vacancy-interstitial pairs per ion (SRIM)
- silicon monovacancies are mobile at room temperature
- vacancies pair with each other or with impurities (dopants, oxygen)
- ~at room temperature, ~90% of the vacancies produced recombine with interstitials

#### **Positron Annihilation**



#### Gamma ray spectrum



### Positrons are trapped by defects



# "S"harpness parameter





#### Figure by Maik Butterling

#### **Positron accelerator**



### **Example: ion-implanted silicon**



#### **Measuring vacancy concentrations**



#### A closer look at annihilation spectra...



# **Chemical "fingerprints"**



#### **Arsenic in silicon**



#### Various fluorides



#### **F-doped silicon**



#### "Reconstruction"



# **New apparatus**



#### In situ ion implantation/positron spectroscopy



#### **Positron Source and Moderator (Ti/Pt)**





# Ramp annealing of 10keV argon implant 1-5 ohm-cm boron-doped silicon



# Isothermal annealing



# Arrhenius plot



Ea ~0.2eV

# Summary

- Interplay among vacancies, interstitials and impurities provides complex microscopic behaviour that drives materials properties
- Positron annihilation can provide pieces of the puzzle to understand this

#### Void formation threshhold: Implant 325 keV He, anneal 800°C.



#### **Void formation threshhold**



#### **Void formation threshhold**



#### **Annealing ambient**



# **Applications**

- Irradiation
- Aging
- Fatigue
- Thermal history
- Thin film growth
- Porosity

- Semiconductors
- Metals
- Polymers
- Ceramics

Ion implantation creates vacancies and interstitials, and introduces impurities

